FAIRCHILD

SEMICONDUCTOR®

IRF634B

N-Channel BFET MOSFET 250 V, 8.1 A, 450 mΩ

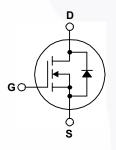
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters and switch mode power supplies.

Features

- 8.1 A, 250 V, $R_{DS(on)}$ = 450 m Ω @ V_{GS} = 10 V
- Low Gate Charge (Typ. 29 nC)
- Low Crss (Typ. 20 pF)
- Fast Switching
- 100% Avalanche Tested
- · Improved dv/dt Capability





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

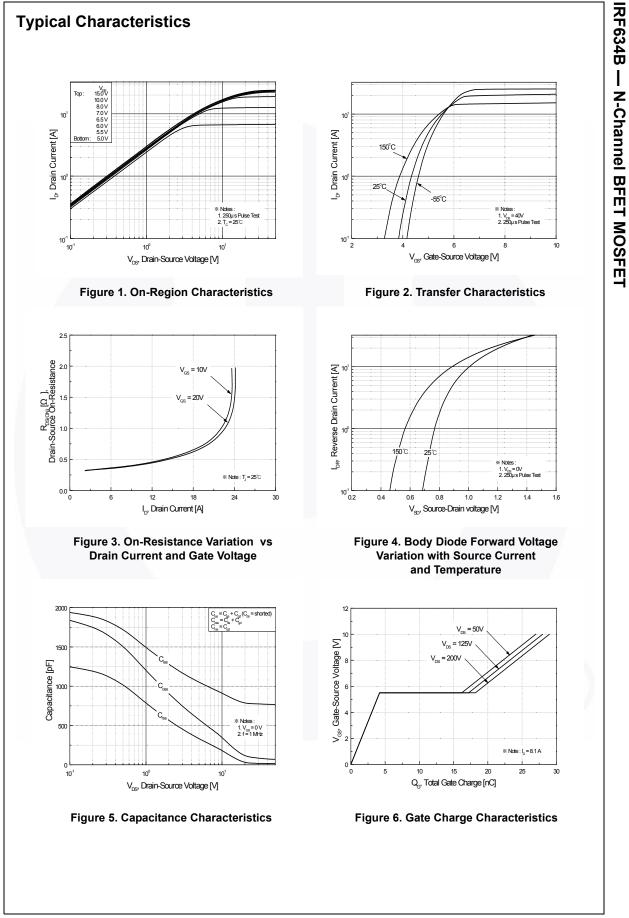
Symbol	Parameter		IRF634B_FP001	Unit
V _{DSS}	Drain-Source Voltage		250	V
I _D	Drain Current - Continuous ($T_C = 25^\circ$	C)	8.1	А
	- Continuous (T _C = 100	°C)	5.1	A
DM	Drain Current - Pulsed	(Note 1)	32.4	A
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	200	mJ
AR	Avalanche Current	(Note 1)	8.1	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	7.4	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.8	V/ns
> D	Power Dissipation (T _C = 25°C)		74	W
	- Derate above 25°C		0.59	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes,		300	°C
· L	1/8" from case for 5 seconds	000	0	

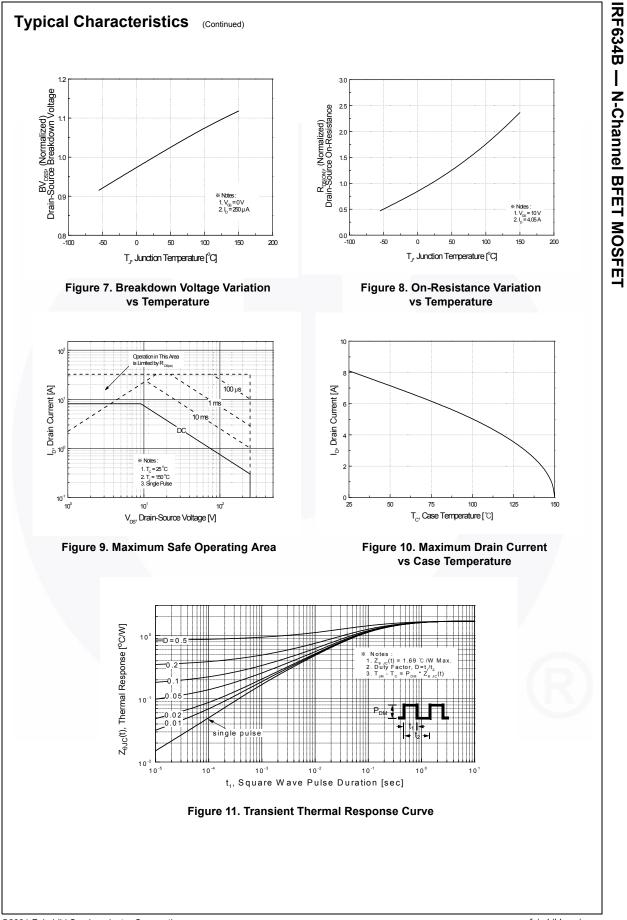
Thermal Characteristics

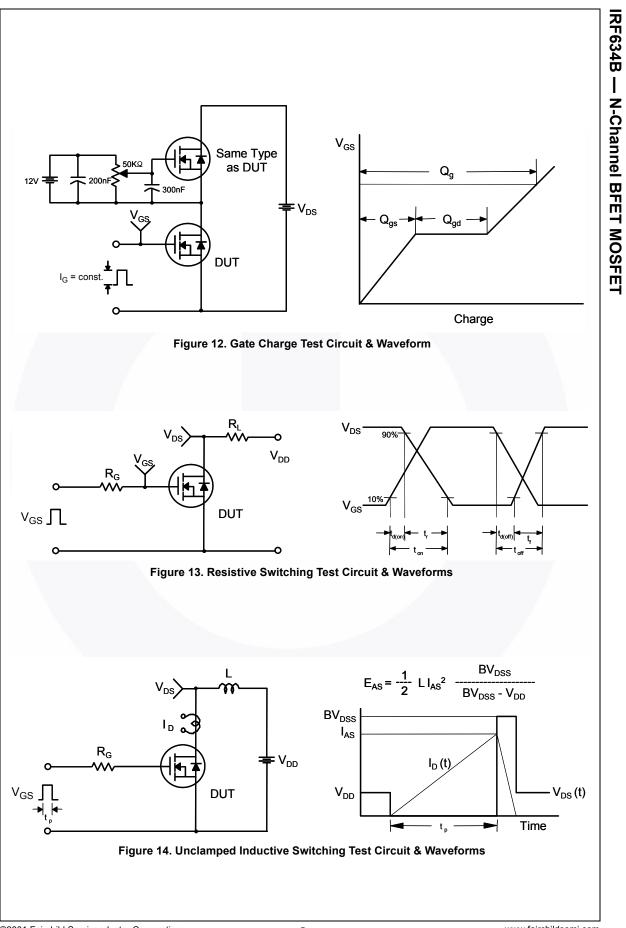
Symbol	Parameter	IRF634B_FP001	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	1.69	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Max.	0.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

December 2013

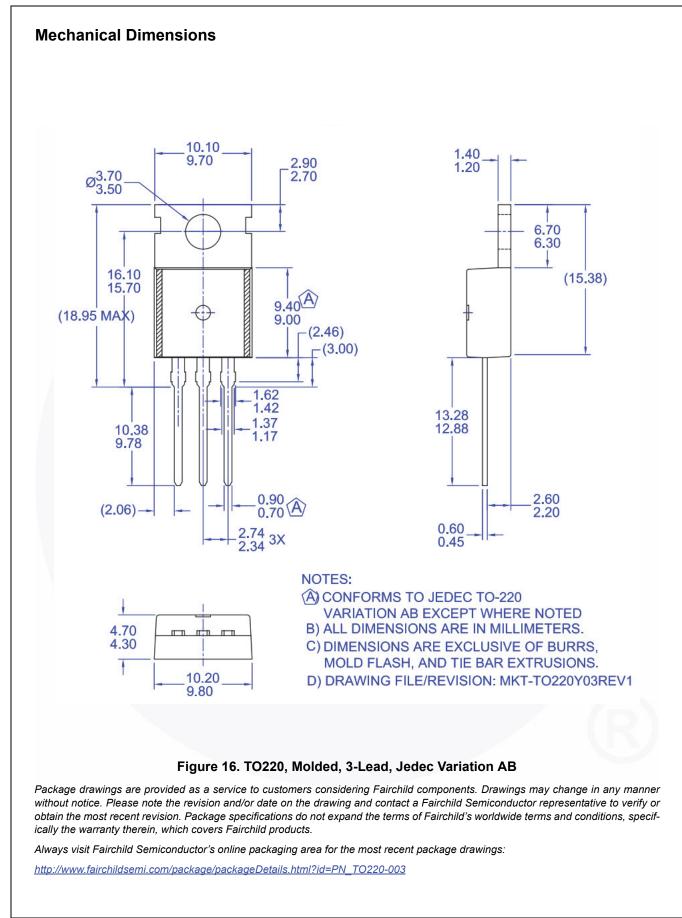
Part Number IRF634B_FP001		Top Mark	Package	Packing Method	Reel Size	Tape Width		Qu	Quantity	
		IRF634B	TO-220	Tube	N/A			50 units		
loctri	al Cha	racteristics	T - 25°C	unless otherwise noted						
Symbol		Parameter	1 _C = 25 C	unless otherwise noted.	ons	Min.	Тур.	Max.	Unit	
Off Cha	racteris	tice			· · · · ·					
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 V, I _D = 250 µ	A	250			V		
ΔBV _{DSS} ′ΔT _J	Breakdown Voltage Temperature Coefficient		I_D = 250 µA, Referenced to 25°C			0.27		V/°C		
DSS	Zero Gate Voltage Drain Current Gate-Body Leakage Current, Forward		urrent	$V_{DS} = 250 \text{ V}, \text{ V}_{GS} = 0$ $V_{DS} = 200 \text{ V}, \text{ T}_{C} = 12$				10 100	μA μA	
I _{GSSF}			t Forward	$V_{\rm DS} = 200 \text{ V}, \ V_{\rm C} = 123 \text{ O}$ $V_{\rm GS} = 30 \text{ V}, \ V_{\rm DS} = 0 \text{ V}$				100	nA	
GSSF		ly Leakage Currer		$V_{GS} = -30 V, V_{DS} = 0 V$				-100	nA	
On Cha	racteris	tice								
V _{GS(th)}		eshold Voltage		V _{DS} = V _{GS} , I _D = 250 μA		2.0		4.0	V	
R _{DS(on)}	Static Dra On-Resis	ain-Source		V _{GS} = 10 V, I _D = 4.05			0.345	0.45	Ω	
JFS	Forward Transconductance		V _{DS} = 40 V, I _D = 4.05 A			7.6		S		
D	o Oh ana									
Dynam C _{iss}		cteristics		<u> </u>	.,		780	1000	pF	
C _{oss}		out Capacitance		$V_{DS} = 25 V, V_{GS} = 0 V,$			95	125	pF	
C _{rss}		Transfer Capacita	nce	f = 1.0 MHz			20	25	pF	
	•				Į					
Switchi	-	acteristics	_	V _{DD} = 125 V, I _D = 8.1	٨		15	40	ns	
a(on) r		Rise Time		$R_{G} = 25 \Omega$	А,		75	160	ns	
d(off)		Delay Time		NG - 20 32	-		100	210	ns	
d(on)	Turn-Off				(Note 4)		65	140	ns	
ମ ପୁ		e Charge		N 000 Y I 0 4	, ,		29	38	nC	
∽y Q _{gs}		Irce Charge		V _{DS} = 200 V, I _D = 8.1 V _{GS} = 10 V	А,		4.2		nC	
∽ _{gs} Q _{gd}		in Charge		V _{GS} - 10 V	(Note 4)		14		nC	
				L						
				nd Maximum Rati	ngs			8.1	A	
ls		n Pulsed Drain-So						32.4	A	
SM				$V_{GS} = 0 V, I_S = 8.1 A$					V	
V _{SD}		urce Diode Forwar Recovery Time	u voltage	$V_{GS} = 0 V, I_S = 8.1 A$ $V_{GS} = 0 V, I_S = 8.1 A$			 170	1.5	_	
t _{rr} Q _{rr}		Recovery Time Recovery Charge		dl _F / dt = 100 A/μs	,		0.91		ns μC	
otes: Repetitive ra	ting : pulse-wi	dth limited by maximum $_{DD} = 50 \text{ V}, \text{ R}_{G} = 25 \Omega, \text{ st}$		iture.					p	
$I_{SD} \le 8.1 \text{ A},$	$di/dt \le 300 \text{ A}$	$V_{\mu}s, V_{DD} \leq BV_{DSS}$, start operating temperature.								







DUT + v_{DS} ۱_{SD} م L Driver R_G, Same Type as DUT L F V_{DD} $\prod V_{GS}$ • dv/dt controlled by R_{G} • I_{SD} controlled by pulse period ſ Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) \mathbf{I}_{FM} , Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{PD} Body Diode Forward Voltage Drop Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



IRF634B — N-Channel BFET MOSFET



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			XS™

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